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| INFORMATION BIOCLOGUES | Filing Date | | 2006-08-03 | |
| INFORMATION DISCLOSURE | First Named Inventor | Wolfgang Borchers | | |
| STATEMENT BY APPLICANT (Not for submission under 37 CFR 1.99) | Art Unit | | | |
| (Not for Submission under or of it 1.00) | Examiner Name | L. | Osborne | |
| | Attorney Docket Number | | 2003P15367WOUS | |

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| | First Named Inventor | Wolfg | gang Borchers | | | |
| | Art Unit | | | | | |
| (Not lot submission under 57 Of K 1.53) | Examiner Name | L. | Osborne | | | |
| | Attorney Docket Numl | oer | 2003P15367WOU | s | | |

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| | Art Unit | | | | | |
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